

To our customers,

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## Old Company Name in Catalogs and Other Documents

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Renesas Electronics website: <http://www.renesas.com>

April 1<sup>st</sup>, 2010  
Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (<http://www.renesas.com>)

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**Phase-out/Discontinued**

**P-CHANNEL POWER MOSFET  
FOR SWITCHING**

**FEATURES**

- Gate drive available at logic level ( $V_{GS} = -4\text{ V}$ )
- High current control available in small dimension due to low  $R_{DS(on)} (\cong 0.45\ \Omega)$
- 2SJ133-Z is a lead process product and is ideal for mounting a hybrid IC.

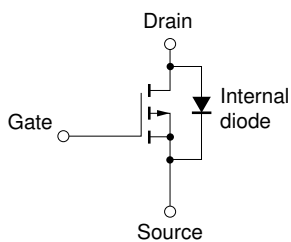
**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ )**

| Parameter               | Symbol         | Conditions   | Ratings                                       | Unit             |
|-------------------------|----------------|--|---|------------------|
| Drain to Source Voltage | $V_{DS}$       | $V_{GS} = 0\text{ V}$                                | -60   | V                |
| Gate to Source Voltage  | $V_{GS}$       | $V_{DS} = 0\text{ V}$                                | $\mp 20$                                      | V                |
| Drain Current (DC)      | $I_{D(DC)}$    | $T_C = 25^\circ\text{C}$                             | $\mp 2.0$                                     | A                |
| Drain Current (pulse)   | $I_{D(pulse)}$ | $PW \leq 300\ \mu\text{s}$<br>duty cycle $\leq 10\%$ | $\mp 8.0$                                     | A                |
| Total Power Dissipation | $P_{T1}$       | $T_C = 25^\circ\text{C}$                             | 20  | W                |
| Total Power Dissipation | $P_{T2}$       | $T_A = 25^\circ\text{C}$                             | 1.0 <sup>Note 1</sup> , 2.0 <sup>Note 2</sup> | W                |
| Channel Temperature     | $T_{ch}$       |  | 150   | $^\circ\text{C}$ |
| Storage Temperature     | $T_{stg}$      |  | -55 to +150                                   | $^\circ\text{C}$ |

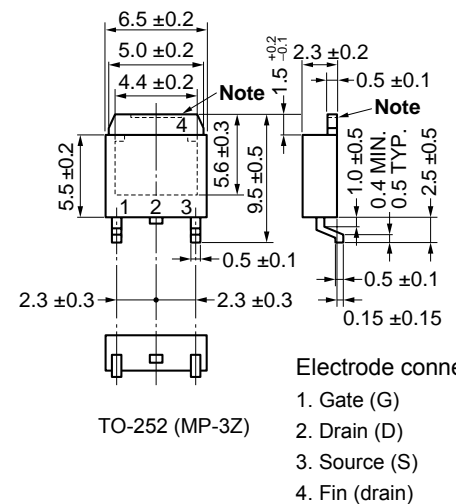
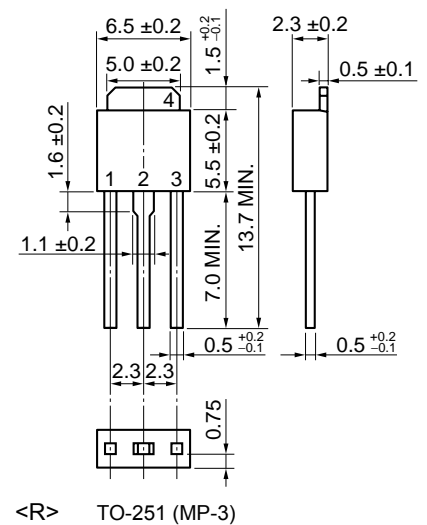
**Note 1.** Printing board mounted

2.  $7.5\text{ cm}^2 \times 0.7\text{ mm}$  ceramic board mounted

**EQUIVALENT CIRCUIT**



**PACKAGE DRAWING (UNIT: mm)**



- Electrode connection
1. Gate (G)
  2. Drain (D)
  3. Source (S)
  4. Fin (drain)

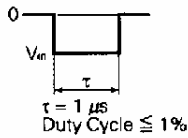
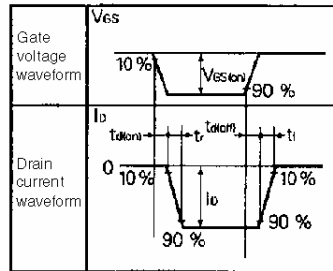
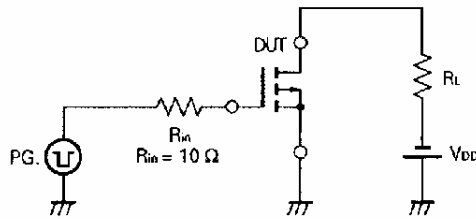
**Note** The depth of notch at the top of the fin is from 0 to 0.2 mm.

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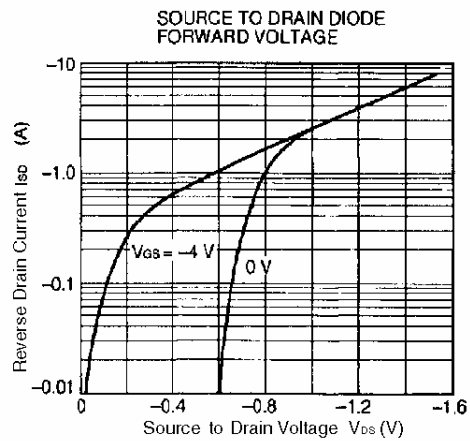
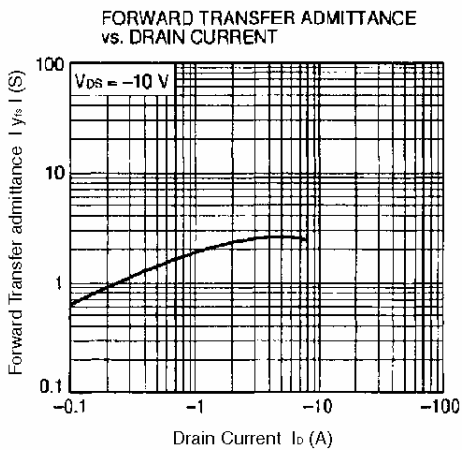
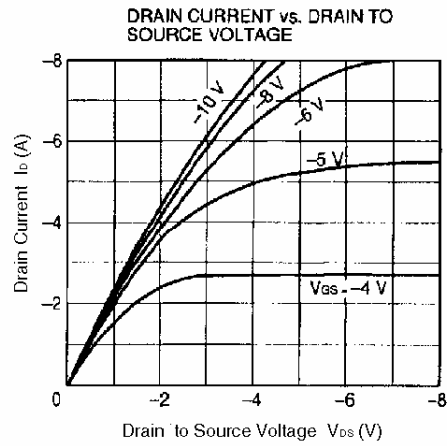
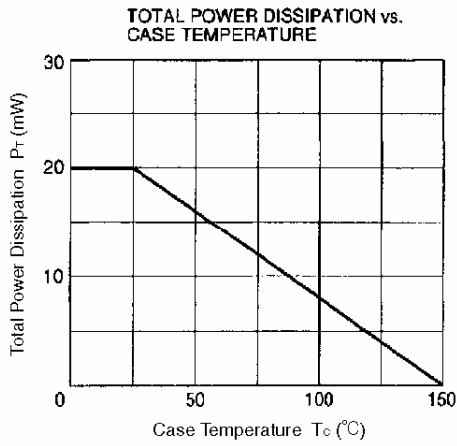
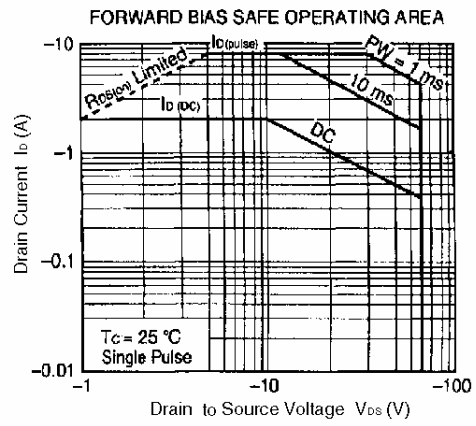
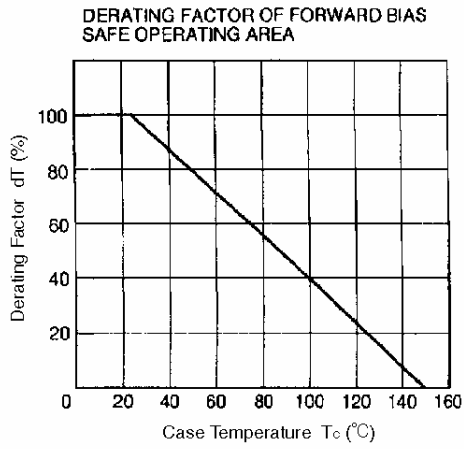
**ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**

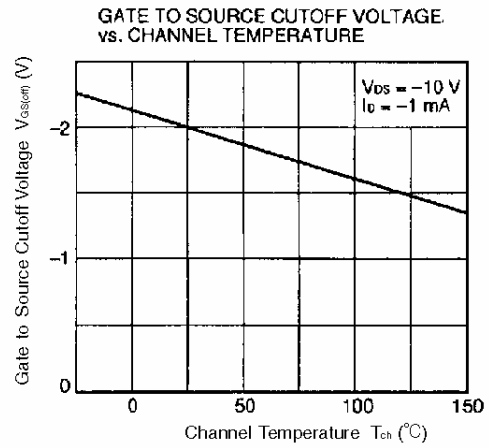
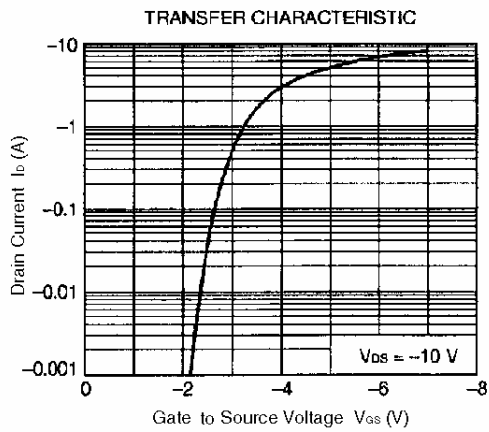
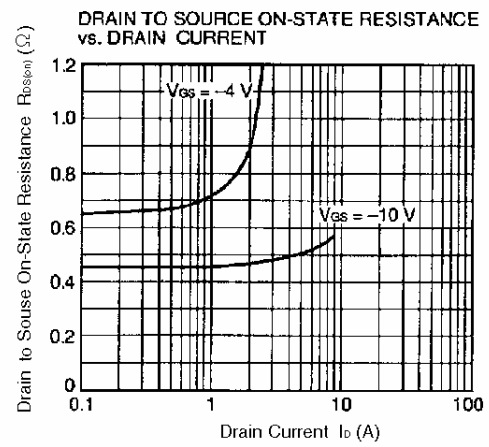
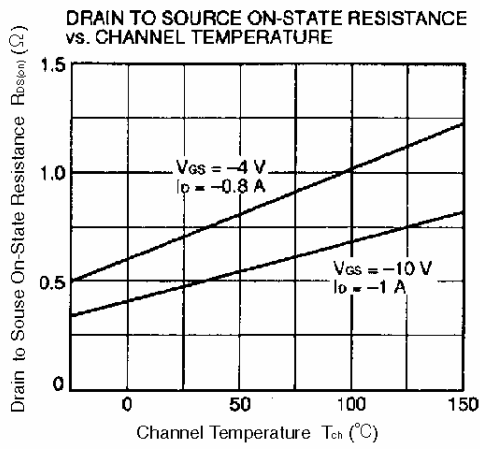
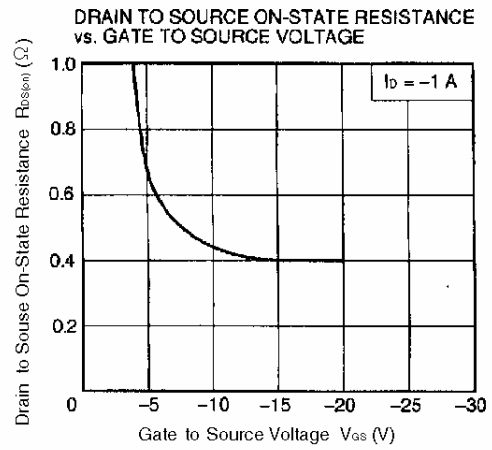
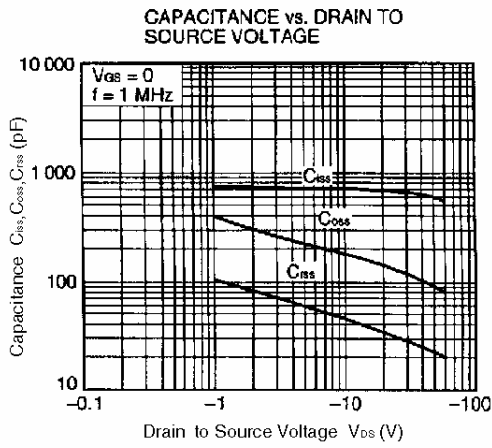
| Parameter                           | Symbol               | Conditions  | MIN. | TYP. | MAX. | Unit |
|-------------------------------------|----------------------|---|------|------|------|------|
| Drain cutoff current                | I <sub>DSS</sub>     | V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V                            |      |      | -10  | μA   |
| Gate cutoff current                 | I <sub>GSS</sub>     | V <sub>GS</sub> = ±20 V, V <sub>DS</sub> = 0 V                            |      |      | ±100 | nA   |
| Gate cutoff voltage                 | V <sub>GS(off)</sub> | V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 mA                         | -1.0 | -2.0 | -3.0 | V    |
| Forward transfer admittance         | y <sub>fs</sub>      | V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1.0 A                          | 1.0  | 1.8  |      | S    |
| Drain to source on-state resistance | R <sub>DS(on)1</sub> | V <sub>GS</sub> = -10 V, I <sub>D</sub> = -1.0 A                          |      | 0.45 | 0.8  | Ω    |
| Drain to source on-state resistance | R <sub>DS(on)2</sub> | V <sub>GS</sub> = -4 V, I <sub>D</sub> = -0.8 A                           |      | 0.7  | 1.3  | Ω    |
| Input capacitance                   | C <sub>iss</sub>     | V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V                            |      | 660  |      | pF   |
| Output capacitance                  | C <sub>oss</sub>     | f = 1 MHz   |      | 250  |      | pF   |
| Reverse transfer capacitance        | C <sub>rss</sub>     |   |      | 50   |      | pF   |
| Turn-on delay time                  | t <sub>d(on)</sub>   | I <sub>D</sub> = -1.0 A, V <sub>GS(on)</sub> = -10 V                      |      | 30   |      | ns   |
| Rise time                           | t <sub>r</sub>       | V <sub>DD</sub> ≅ -30 V, R <sub>L</sub> = 30 Ω,<br>R <sub>in</sub> = 10 Ω |      | 30   |      | ns   |
| Turn-off delay time                 | t <sub>d(off)</sub>  |   |      | 110  |      | ns   |
| Fall time                           | t <sub>f</sub>       |   |      | 40   |      | ns   |

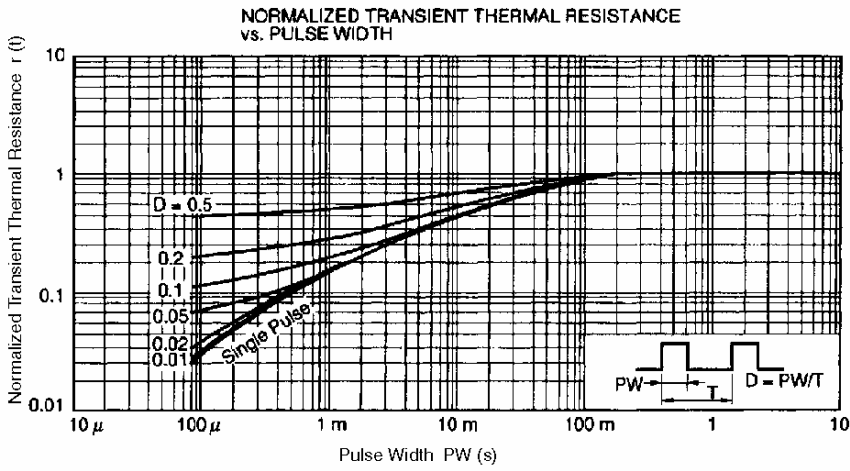
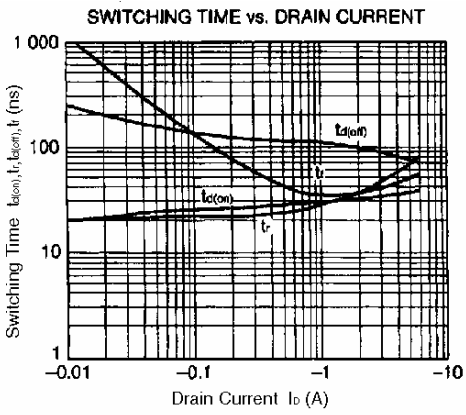
**SWITCHING TIME TEST CIRCUIT, TEST CONDITION (RESISTANCE LOAD)**



**TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)**







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